



Product Change Notification

Change Notification #: 116700 - 00
Change Title: Select Intel® SSD DC P4610 Series,
PCN 116700-00, Product Design,
Firmware Update
Date of Publication: January 11, 2019

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

| | |
|---|----------------|
| Date Customer Must be Ready to Receive Post-Conversion Material: | April 11, 2019 |
|---|----------------|

Description of Change to the Customer:

The Intel® SSD DC P4610 Series SKUs listed in the products affected table below will have the following change.

- The Intel® SSD DC P4610 Series firmware version is being updated from VDV10140 to VDV10152. The changes in the new firmware version are incremental improvements from previous version. Inventory will transition in the Intel factory on or beyond the above date to replace older firmware version with the latest version.

Customer Impact of Change and Recommended Action:

Since the firmware update has incremental improvement over the previous version, Intel anticipates no product impact with this firmware, and re-qualification is not recommended.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

| Marketing Name | Product Code | MM# | Pre Change TA | Pre Change SA | Post Change TA | Post Change SA |
|---|-----------------|--------|---------------|---------------|----------------|----------------|
| Intel® SSD DC P4610 Series (7.6TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack | SSDPE2KE076T801 | 963520 | K19619-000 | K19627-000 | K19619-001 | K19627-001 |
| Intel® SSD DC P4610 Series (1.6TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack | SSDPE2KE016T801 | 978083 | K19620-000 | K19626-000 | K19620-001 | K19626-001 |
| Intel® SSD DC P4610 Series (3.2TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack | SSDPE2KE032T801 | 978084 | K19622-100 | K19625-100 | K19622-101 | K19625-101 |
| Intel® SSD DC P4610 Series (6.4TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack | SSDPE2KE064T801 | 978085 | K19621-000 | K19624-000 | K19621-001 | K19624-001 |

PCN Revision History:

Date of Revision:

January 11, 2019

Revision Number:

00

Reason:

Originally Published PCN



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116700 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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